74HC2G32-Q100; 74HCT2G32-Q100 Dual 2-input OR gate Rev. 4 — 17 November 2023

Product data sheet

1. General description

The 74HC2G32-Q100; 74HCT2G32-Q100 is a dual 2-input OR gate. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1) Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- Input levels:
 - For 74HC2G32-Q100: CMOS level
 - For 74HCT2G32-Q100: TTL level
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standard: JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

3. Ordering information

Table 1. Ordering information

Type number	Package									
	Temperature range	Name	Description Ver							
74HC2G32DP-Q100 74HCT2G32DP-Q100	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	<u>SOT505-2</u>						
74HC2G32DC-Q100 74HCT2G32DC-Q100	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	<u>SOT765-1</u>						

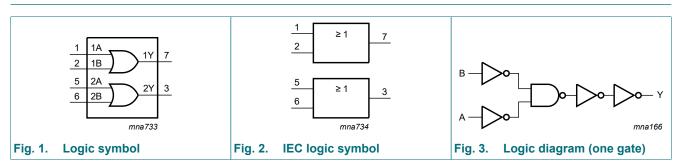
4. Marking

Table 2. Marking code							
Type number	Marking code [1]						
74HC2G32DP-Q100	H32						
74HCT2G32DP-Q100	T32						
74HC2G32DC-Q100	H32						
74HCT2G32DC-Q100	T32						

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

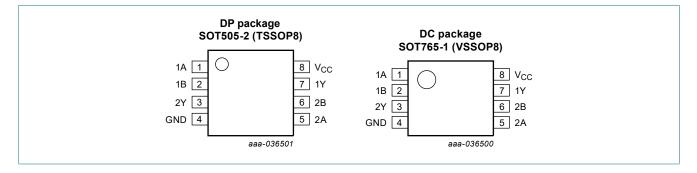
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5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

Table 3. Pin	description
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Symbol	Pin	Description
1A, 2A	1, 5	data input
1B, 2B	2, 6	data input
GND	4	ground (0 V)
1Y, 2Y	7, 3	data output
V _{CC}	8	supply voltage

7. Functional description

Table 4. Function table

H = *HIGH* voltage level; *L* = *LOW* voltage level.

Input	Output	
nA	nB	nY
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	[1]	-	±20	mA
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	[1]	-	±20	mA
lo	output current	$V_{\rm O}$ = -0.5 V to (V _{CC} + 0.5 V)	[1]	-	25	mA
I _{CC}	supply current		[1]	-	50	mA
I _{GND}	ground current		[1]	-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
PD	dynamic power dissipation	T_{amb} = -40 °C to +125 °C	[2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT505-2 (TSSOP8) package: P_{tot} derates linearly with 4.6 mW/K above 96 °C.

For SOT765-1 (VSSOP8) package: Ptot derates linearly with 4.9 mW/K above 99 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions 74HC2G		C2G32-0	2G32-Q100 74		74HCT2G32-Q100		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C		-40 °C to	-40 °C to +85 °C		-40 °C to +125 °C		
			Min	Тур	Max	Min	Max	Min	Max	
74HC2G	32-Q100									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C t	Unit	
			Min	Тур	Max	Min	Мах	Min	Max	1
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
	voltage	I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	4.18	4.32	-	4.13	-	3.7	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.68	5.81	-	5.63	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
	voltage	I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	1.0	-	10	-	20	μA
CI	input capacitance		-	1.5	-	-	-	-	-	pF
74HCT2	G32-Q100	• •								
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V_{I} = V_{IH} or V_{IL} ; V_{CC} = 4.5 V								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
	voltage	I _O = -4.0 mA	4.18	4.32	-	4.13	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
	voltage	I _O = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	1.0	-	10	-	20	μA
ΔI _{CC}	additional supply current	per input; $V_{CC} = 4.5 V \text{ to } 5.5 V;$ $V_I = V_{CC} - 2.1 V; I_O = 0 A$	-	-	300	-	375	-	410	μA
CI	input capacitance		-	1.5	-	-	-	-	-	pF

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.

Symbol	Parameter Conditions			25 °C				0 °C to -85 °C		-40 °C to +125 °C	
				Min	Тур	Max	Min	Max	Min	Мах	1
74HC2G	32-Q100	J	I								
t _{pd}	propagation	nA, nB to nY; see Fig. 4	[1]								
	delay	V _{CC} = 2.0 V		-	24	75	-	95	-	110	ns
		V _{CC} = 4.5 V		-	9.0	15	-	19	-	22	ns
		V _{CC} = 6.0 V		-	7.0	13	-	16	-	20	ns
t _t	transition time	nY; see <u>Fig. 4</u>	[2]								
		V _{CC} = 2.0 V		-	18	75	-	95	-	125	ns
		V _{CC} = 4.5 V		-	6	15	-	19	-	25	ns
		V _{CC} = 6.0 V			5	13	-	16	-	20	ns
C _{PD}	power dissipation capacitance	per buffer; C _L = 50 pF; $f_i = 1 \text{ MHz}$; V _I = GND to V _{CC}	[3]	-	10	-	-	-	-	-	pF
74HCT2	G32-Q100		I						I		
t _{pd}	propagation delay	nA, nB to nY; V _{CC} = 4.5 V; see <u>Fig. 4</u>	[1]	-	13	24	-	30	-	36	ns
t _t	transition time	nY; V _{CC} = 4.5 V; see <u>Fig. 4</u>	[2]	-	6	15	-	19	-	22	ns
C _{PD}	power dissipation capacitance	per buffer; C _L = 50 pF; $f_i = 1 \text{ MHz}$; V _I = GND to V _{CC} - 1.5 V	[3]	-	11	-	-	-	-	-	pF

 t_{pd} is the same as t_{PLH} and t_{PHL} . [1]

[2] [3]

 t_t is the same as t_{TLH} and t_{THL} . C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

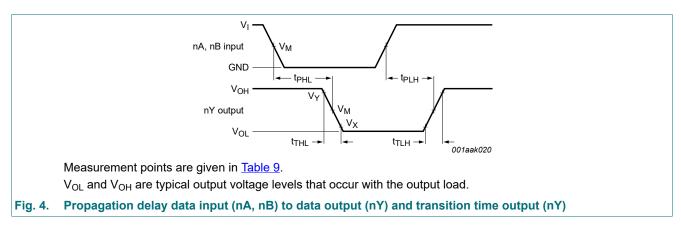
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_1 \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$

11.1. Waveforms and test circuit



Туре	Input	Output	Output						
	V _M	V _M	V _M V _X V _Y						
74HC2G32-Q100	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}					
74HCT2G32-Q100	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}					



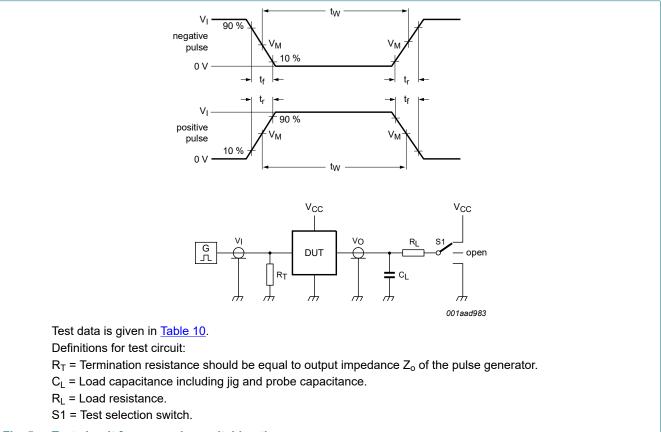


Fig. 5. Test circuit for measuring switching times

Table 10. Test data

Туре	Input		Load		S1 position
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}
74HC2G32-Q100	GND to V _{CC}	≤ 6 ns	50 pF	1 kΩ	open
74HCT2G32-Q100	GND to 3 V	≤ 6 ns	50 pF	1 kΩ	open

12. Package outline

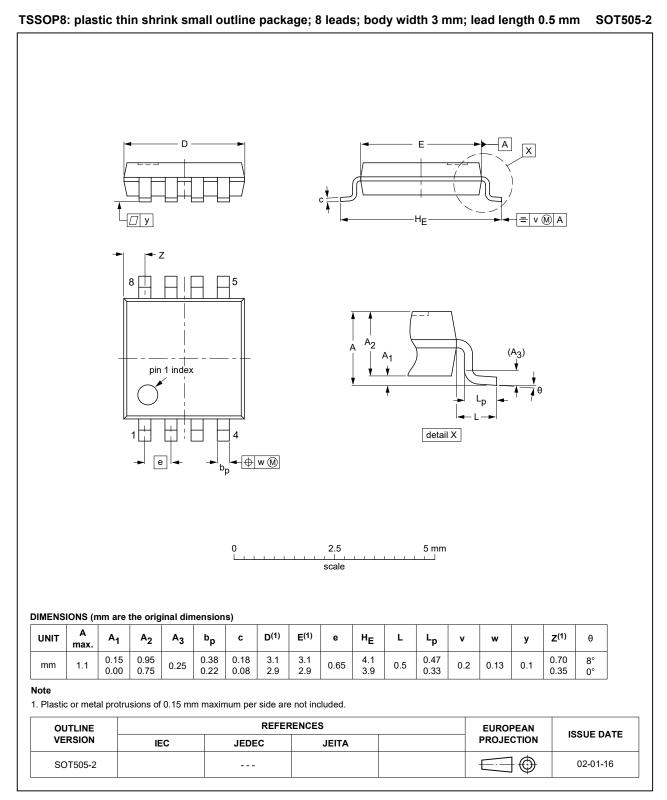


Fig. 6. Package outline SOT505-2 (TSSOP8)

74HC_HCT2G32_Q100

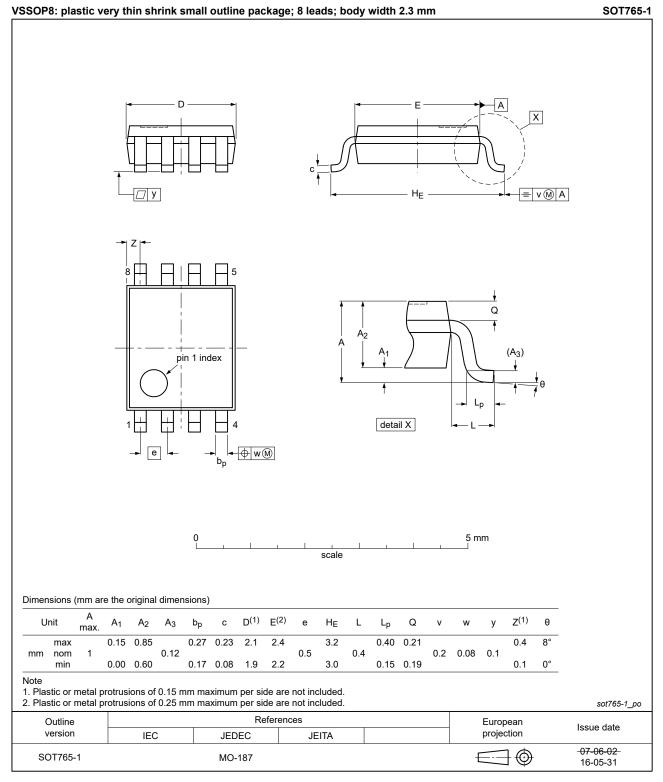


Fig. 7. Package outline SOT765-1 (VSSOP8)

13. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
TTL	Transistor-Transistor Logic		

14. Revision history

Table 12. Revision history **Document ID Release date** Data sheet status Change notice Supersedes 74HC_HCT2G32_Q100 v.4 20231117 Product data sheet 74HC_HCT2G32_Q100 v.3 _ Modifications: Section 2 updated. • Section 2: ESD specification updated according to the latest JEDEC standard. • Section 8: Derating values for Ptot total power dissipation updated. 74HC_HCT2G32_Q100 v.3 Product data sheet 74HC_HCT2G32_Q100 v.2 20190208 Modifications: The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. Package outline drawing SOT765-1 (VSSOP8) updated. 74HC_HCT2G32_Q100 v.2 20140106 Product data sheet 74HC_HCT2G32_Q100 v.1 Modifications: For 74HCT2G32-Q100 the conditions of CPD are corrected to the family standard (errata). 74HC_HCT2G32_Q100 v.1 Product data sheet 20131021

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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Dual 2-input OR gate

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